

July 2026 plenary meeting series

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Abraham, Shiju	Acsia Technologies	Acsia Technologies	1	4	4	1	10	0
Abramczyk, Jaroslaw		Coherent	1	4	4	0	9	0
Ahuja, Ramanjit	ON Semiconductor	ON Semiconductor	1	3	4	2	10	0
Akinwale, Oluwafemi	Intel Corporation	Intel Corporation	1	4	4	1	10	0
Alloin, Laurent		Ciena Corporation	1	4	3	2	10	0
Alwishah, Abbas	Molex Incorporated	Molex Incorporated	0	3	4	2	9	0
Anantha Murthy, Vijay	Keysight Technologies Inc	Keysight Technologies Inc	0	0	0	1	1	0
Baek, Brian		Apple Inc.	1	2	2	0	5	0
Baggett, Tim	Microchip Technology, Inc.	Microchip Technology, Inc.	1	4	3	2	10	1
Bar-Niv, Amir	Infineon Technologies	Infineon Technologies	1	5	2	1	9	0
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	4	4	0	9	0
Benyamin, Saied	Ethernovia	Ethernovia	1	5	4	1	11	0
Bernier, Eric	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada Co., Ltd.	1	4	3	2	10	0
Boiger, Christian	Infineon Technologies	Infineon Technologies	0	1	0	0	1	0
Borrill, Paul	DAEDAEUS	DAEDAEUS	0	1	0	0	1	0
Boyer, Rich	Aptiv - Signal and Power Solutions	Aptiv Signal and Power Solutions	1	5	3	2	11	0
Brillhart, Theodore	Fluke Corporation	Fluke Corporation	1	5	3	2	11	0
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions	1	3	4	2	10	0
Brown, Matthew	Alphawave Semi	Qualcomm	1	4	4	1	10	0
Bruckman, Leon	NVIDIA	NVIDIA	1	4	3	2	10	0
Budweiser, Karl	BMW AG	BMW AG; BMW Group	1	4	4	2	11	0
Calvin, John	Keysight Technologies	Keysight Technologies	1	4	3	2	10	0
Castro, Jose	Panduit	Panduit Corp.	1	4	4	2	11	0
Chandler-Page, Michael		Cirrus Logic	0	3	1	0	4	0
Chang, Jae-yong	Keysight Technologies Inc	Keysight Technologies Inc	1	4	4	2	11	0
Chang, Yongmao	Inphi Corporation	Source Photonics	0	4	4	2	10	0
Chen, Chan	Self Employed	Independent/AOI	1	4	4	2	11	0

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Chen, Lihao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	0	0	0	1	0
cheng, xiaoyue		Infineon Technologies	1	3	4	1	9	0
Chidambaram, Valliaappan	Acsia Technologies	Acsia Technologies	1	3	4	1	9	0
Chimento, Nicholas		Analog Devices Inc.	1	3	4	2	10	0
Chini, Ahmad	Broadcom Corporation	Broadcom Corporation	1	4	3	2	10	0
Choudhury, Golam	Genuine Optics	Genuine Optics	1	4	4	2	11	0
Chow, Kai Soon		Apple Inc.	1	4	4	0	9	0
Chughtai, Muhammad Saad		Tektronix, Inc.	0	0	2	1	3	0
Cole, Christopher R	Coherent Corporation	Coherent Corp.	1	4	4	1	10	0
Cordaro, Joseph	Infineon Technologies	Infineon Technologies	1	5	2	2	10	0
D'Ambrosia, John	Futurewei Technologies, U.S. Subsidiary of Huawei	Futurewei Technologies, U.S. Subsidiary of Huawei	1	4	4	2	11	0
Dai, Shaoan		Infineon Technologies	1	4	4	2	11	0
Dar, Marva	TE Connectivity	TE Connectivity	1	4	4	2	11	0
Dawe, Piers J G	NVIDIA	Nvidia	1	4	4	2	11	0
de Koos, Andras	Microchip Technology Inc	Microchip Technology Inc	1	4	4	1	10	0
Djahanshahi, Hormoz	Microchip Technology, Inc.	Microchip Technology, Inc.	1	3	4	2	10	0
Donahue, Curtis	Rohde & Schwarz	Rohde & Schwarz	1	5	3	2	11	0
Dsilva, Hansel		Amphenol Corporation	1	4	4	2	11	0
Dudek, Michael	Marvell	Marvell	1	4	3	2	10	0
Edele, Jonas		BMW AG; BMW Group	1	4	4	0	9	0
Elzur, Uri	NVIDIA Corporation	NVIDIA Corporation	0	1	0	0	1	0
Engenhardt, Klaus		Teradyne, Inc. & Quantifi Photonics	0	2	1	0	3	0
Estes, David	Spirent Communications	VIAVI Solutions	1	4	4	2	11	0
Estrakh, Daniel	Valens Semiconductor	Valens Semiconductor	1	4	4	2	11	0
Fedyk, Donald	LabN Consulting, L.L.C.	Nortel Networks	0	0	0	0	0	0

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Ferretti, Vincent	Corning Incorporated	Corning Incorporated	1	4	4	0	9	0
Fuller, Paul		Infineon Technologies	1	4	3	1	9	0
Galan, Jose	MaxLinear, Inc.	MaxLinear, Inc.	1	4	4	2	11	0
Gareau, Sebastien		Ciena Corporation	1	4	3	1	9	0
Gauthier, Claude	ForestSemi	ForestSemi	0	0	3	0	3	0
Geng, Limin	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	4	4	1	10	0
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC; Marvell Semiconductor, Inc.	1	3	3	2	9	0
Gilb, James	General Atomics Aeronautical Systems, Inc.	General Atomics Aeronautical Systems, Inc.	0	2	0	0	2	0
Glanzner, Martin	SEI ANTech-Europe GmbH	SEI Automotive Europe GmbH	0	3	2	2	7	0
Goel, Sachin	Aviva Links Inc	NXP	1	4	4	1	10	0
Gorshe, Steven Scott	Microchip Technology, Inc.	Microchip Technology, Inc.	1	4	3	2	10	0
Goto, Hideki	Toyota Motor Corporation	Toyota Motor Corporation	1	5	4	2	12	0
Graber, Steffen	Pepperl+Fuchs SE	Pepperl+Fuchs SE	0	0	0	1	1	0
Gubow, Martin	Keysight Technologies	Keysight Technologies	1	4	2	2	9	2
Hameed, Anil		Acsia Technologies	1	4	4	0	9	0
Hamilton, Mark	Cadence Design Systems	Cadence Design Systems	1	4	4	2	11	0
Han, Ruibo	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)	1	2	4	0	7	0
Hand, Steven		Nokia	1	3	4	1	9	0
HE, MICHAEL	TeraHop Pte. Ltd.	TeraHop Pte. Ltd.	1	4	4	0	9	0
He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	5	4	2	12	0
Healey, Adam	Broadcom Inc.	Broadcom Inc.	1	4	3	2	10	0
Heck, Howard	TE Connectivity	TE Connectivity	1	2	4	2	9	0
Helely, Oren		Marvell Semiconductor, Inc.	1	4	4	0	9	0
Hiroaki, Kukita	Yamaichi Electronics	Yamaichi Electronics	1	4	4	2	11	0
Hogenmueller, Thomas	Robert Bosch GmbH	Robert Bosch GmbH	1	3	3	2	9	0

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Holdrege, Matthew	Microchip Technology, Inc.	Microchip Technology, Inc.	0	2	3	2	7	0
Hon, Kam Yan		Cisco Systems, Inc.	0	0	1	0	1	0
Houck, TJ	Infineon Technologies	Infineon Technologies	0	5	4	1	10	0
Hu, Runlong		China Mobile Communications Group Co.,Ltd; China Mobile Communications Group Co.,Ltd	0	0	1	0	1	0
Huang, Guangping	ZTE Corporation	ZTE Corporation	0	2	0	0	2	0
Huang, Kechao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	4	4	1	10	0
Huang, Michael		Berxel	0	0	0	0	0	0
Huber, Thomas	Nokia	Nokia	1	4	4	2	11	0
Hutchison, Guy	Aviva Links	NXP Semiconductors	1	3	4	1	9	0
HYAKUTAKE, YASUHIRO	Orbray Co., Ltd.	Orbray Co., Ltd.	1	5	4	2	12	0
Irwin, Scott	MoSys, Inc.	ADTRAN Inc.	1	4	4	2	11	0
Isono, Hideki	Furukawa FITEL Optical Components Limited	Furukawa FITEL Optical Components	1	4	4	2	11	0
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co., Ltd	1	4	4	2	11	0
Iwasaki, Yutaka	Hirose Electric Co.,Ltd.	Hirose Electric Co., Ltd.	1	2	1	0	4	0
Jackson, Kenneth	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD	1	4	3	2	10	0
Jeffreis, Brad		Analog Devices Inc.	1	3	4	2	10	0
Jin, Robert	Montage Technology, Inc	Montage Technology	1	5	3	0	9	0
Jochim, Markus	NXP Semiconductors	General Motors Company	1	5	4	2	12	0
Johnson, John	Broadcom Corporation	Broadcom Corporation	1	4	4	2	11	0
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	2	2	9	0
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	3	2	10	2
Jonsson, Ragnar	Infineon Technologies	Marvell	1	4	2	2	9	0
Joseph, Gloria	Acsia Technologies	Acsia Technologies	1	4	4	0	9	0
Kabra, Lokesh	Synopsys, Inc.	Synopsys, Inc.	0	0	0	0	0	0
Kagami, Manabu	Nagoya Institute of Technology	Nagoya Institute of Technology (NITech)	1	5	3	1	10	0

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Kandarpa, Venkata	NXP Semiconductors	NXP Semiconductors	1	2	2	2	7	0
Kapoor, Samay	Aviva Links	Aviva Links Inc.	1	2	2	1	6	0
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	4	2	11	0
KATO, TAKAHIRTO	Dexerials	Dexerials	1	4	4	0	9	0
Kim, DoKyun	LG ELECTRONICS	LG ELECTRONICS	1	5	4	1	11	0
Kim, Gyudong	Analog Devices Inc.	Analog Devices Inc.	1	5	4	2	12	0
Kim, Yongbum	General Motors Company	General Motors Company	1	5	4	2	12	0
Kimber, Eric	Semtech Ltd	Semtech Ltd	1	4	4	2	11	0
Kleinwaechter, Mathias	in-tech GmbH	in-tech GmbH	1	4	4	2	11	0
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	3	2	10	0
Kock, Joerg	NXP Semiconductors	NXP Semiconductors	1	4	4	2	11	0
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation	1	4	4	0	9	0
Kondo, Taiji	Dexerials Corporation	Dexerials Corporation	1	4	4	0	9	0
Kota, Kishore	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	4	4	1	10	0
Kotani, Yasuhiro	DENSO	DENSO	0	5	3	1	9	0
Kutscher, Noam	Marvell Semiconductor, Inc.	Marvell	0	4	4	2	10	0
Lackner, Hans	QoSCom GmbH	QoSCom GmbH	1	4	4	2	11	0
Landry, Gary	Coherent Corp.	Coherent	1	4	4	2	11	0
Lasry, Ariel	Qualcomm Technologies, Inc	Qualcomm Technologies, Inc	1	4	4	2	11	0
Law, Andrew	Student	Self	0	2	2	2	6	0
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	4	4	2	11	0
Lee, Ching-Yen		Realtek Semiconductor Corp.	1	4	2	2	9	0
Lee, Dongjae		Newracom Inc.	0	2	2	2	6	0
Lee, Sylvanus	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	3	4	2	10	0
Lessard, Stephane	Ericsson AB	Ericsson AB	0	3	4	1	8	1
Lewis, David	SPECIPHY / Lumentum	SPECIPHY, LUMENTUM	1	4	4	2	11	0
Lewis, Jon	Dell Technologies	Dell Technologies	1	4	2	2	9	0

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Li, Jieyu		China Mobile Communications Group Co.,Ltd; China Mobile Communications Group Co.,Ltd	0	1	0	0	1	0
Li, Jing	YOFC	YOFC	1	2	0	0	3	0
Li, Mike-Peng	Altera Corporation	Intel Corporation	1	4	4	2	11	0
Li, Pei-Rong	MediaTek Inc.	MediaTek Inc.	1	4	3	2	10	0
Lieder, Eyal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	4	3	2	10	0
Lim, Hoei	NXP Semiconductors	NXP Semiconductors	1	3	3	2	9	0
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	3	2	10	0
Lin, YK	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	1	4	2	2	9	2
Little, Terrance	Foxconn Electronics Inc.	Foxconn Electronics Inc.	1	5	3	2	11	0
Liu, Cathy	Broadcom Corporation	Broadcom Corporation	1	3	4	2	10	0
Lo, William	Axonne Inc.	Axonne Inc.	1	5	4	0	10	0
Long, Richard	TE Connectivity	TE Connectivity	1	5	4	1	11	0
Lou, David		Huawei Technologies Duesseldorf GmbH	0	1	0	1	2	0
Lou, Wei		Broadcom Corporation	1	4	4	0	9	0
lu, chao	BMW Group	BMW Group	1	3	4	1	9	0
Lusted, Kent	Synopsys, Inc.	Synopsys, Inc.	1	4	3	2	10	0
Lyu, Yunping(Lily)	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	5	4	0	10	0
Maguire, Valerie	Copperopolis	Copperopolis (affl with CME Consulting, Cisco, Microchip, and NXP)	1	4	4	2	11	0
Maki, Jeffery	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	5	3	2	11	0
Maniloff, Eric	Ciena Corporation	Ciena Corporation	1	3	4	2	10	0
Marques, Flavio	Lightera	Lightera	1	4	4	2	11	0
Mascitto, Marco	Nokia Canada Inc.	Nokia	1	3	4	2	10	0
Matuz, Balazs		Huawei Technologies Duesseldorf GmbH	1	5	4	2	12	0

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Mazhar Sarmadi, Mehrnoosh	MD Elektronik	MD Elektronik	0	0	1	0	1	0
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	3	1	9	0
Mecklenburg, Ben		Huawei Technologies Duesseldorf GmbH	1	5	4	2	12	0
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.	1	4	4	0	9	0
mi, guangcan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	5	3	2	11	0
Miskho, Michael		Analog Devices Inc.	1	5	4	1	11	0
Moorwood, Charles	Keysight Technologies	Keysight Technologies	1	4	4	1	10	0
Muller, Shimon	Enfabrica Corp.	Enfabrica	1	4	4	2	11	0
Muma, Scott	Microchip Technology, Inc.	Microchip Technology, Inc.	1	4	4	2	11	0
MURAKAMI, YUKI	1Finity	1Finity	1	4	4	2	11	0
Murray, Brian	Analog Devices Inc.	Analog Devices Inc.	1	4	3	2	10	0
Murty, Ramana	Broadcom Inc.	Broadcom Corporation	1	4	4	2	11	0
Muth, Karlheinz	Broadcom Corporation	Broadcom Corporation	1	4	2	2	9	0
Nering, Raymond	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	3	2	10	0
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	4	2	11	0
Nicholl, Shawn	Advanced Micro Devices (AMD)	Advanced Micro Devices (AMD)	1	4	3	2	10	0
NIIHARA, YOSHIHIRO	Fujikura Ltd.	Fujikura Ltd.	1	5	4	2	12	0
Nikolich, Paul	Paul Nikolich	Paul Nikolich; Representing myself	0	1	0	0	1	0
Ninomiya, Tiger	Accelink USA Corporation	Accelink / Self	1	4	4	2	11	0
Noseworthy, Bob	University of New Hampshire	University of New Hampshire	0	1	0	0	1	0
Noujeim, Leesa	Google	Google	0	4	4	0	8	0
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	3	2	10	0
Nowroozi, Bijan	Lightmatter	Lightmatter	0	2	3	2	7	0
Ofelt, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	4	3	2	10	0
Oishi, Eiichiro		Yazaki Corporation	1	5	4	2	12	0
Omori, Kumi	NEC Corporation	NEC Corporation	1	4	3	2	10	0

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Opsasnick, Eugene	Broadcom Inc.	Broadcom Inc.	1	4	4	2	11	0
Osorio, Luz	Nokia Canada Inc.	Nokia	1	3	3	2	9	0
Ota, Keisuke		Murata Electronics North America, Inc.	0	1	1	0	2	0
Pal, Debajyoti		ON Semiconductor	1	5	4	1	11	0
Palkert, Thomas	Samtec, Inc.	Samtec, Inc.	1	4	3	2	10	0
Pan, Chunpo		Broadcom Corporation	1	4	3	2	10	0
Park, Pusik		Korea Electronics Technology Institute (KETI); Korea Electronics Technology Institute (KETI); Korea Electronics Technology Institute (KETI); Korea Electronics Technology Institute (KETI)	1	5	2	2	10	0
Parkholm, Ulf	Telefon AB LM Ericsson	Ericsson AB	1	3	2	2	8	2
Parsons, Earl	CommScope Amphenol	CommScope, Inc.	1	4	0	2	7	0
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation	1	5	4	0	10	0
Pepper, Gerald	Keysight Technologies	Keysight Technologies	1	4	3	2	10	0
Perez De Aranda Alonso, Ruben	Knowledge Development for POF SL	Cisco Systems, Inc.	1	4	4	2	11	0
Potterf, Jason	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	2	2	9	0
Rabinovich, Rick	Keysight Technologies	Keysight Technologies	1	4	4	2	11	0
Rajagopal, Karthik	Texas Instruments Inc.	Texas Instruments Inc.	1	4	3	2	10	0
Ran, Adee	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	2	2	9	0
Ransford, Michael		Corning Incorporated	1	4	4	2	11	0
Razavi, Alireza	Eliyan	Eliyan	1	5	4	1	11	0
Regev, Alon	Keysight Technologies	Keysight	0	0	0	0	0	4
Reinhard, Michael	SEI Automotive Europe GmbH	SEI Automotive Europe GmbH	1	2	2	2	7	0
Ren, Hao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	4	4	2	11	0
Rodes, Roberto	II-VI	II-VI	1	4	4	1	10	0
Rysin, Alexander	NVIDIA	NVIDIA	1	4	4	0	9	0
Sakai, Toshiaki	Socionext Inc.	socionext	1	4	3	2	10	0

Maximum of 4 reciprocal credits are allowed

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Salata, Carlo	Canova Tech	Canova Tech	1	5	4	1	11	0
Sambasivan, Sam	AT&T;	AT&T;	0	4	4	2	10	0
Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated	1	4	4	2	11	0
Schedl, Anton	BMW Group	BMW Group	1	4	4	0	9	0
Schindler, Manfred	Self	Self	1	0	0	0	1	0
Schreiner, Stephan	Rosenberger Hochfrequenztechnik GmbH & Co. KG	Rosenberger	1	4	4	2	11	0
Sedarat, Hossein	Ethernovia	Ethernovia	1	3	4	2	10	0
Shah, Anup	Siemens Corporation	Siemens EDA	1	4	3	1	9	0
Shakiba, Mohammad	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada; Huawei Technologies Co., Ltd	1	4	4	2	11	0
Sharma, Rohit		Molex Incorporated	0	2	0	0	2	0
Sharon, Ari		Terawand	1	3	2	0	6	0
Shiino, Masato	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC	1	5	4	2	12	0
Shoval, Ayal	Synopsys, Inc.	Synopsys, Inc.	1	4	3	2	10	0
Shrikhande, Kapil	Marvell Semiconductor, Inc.	Upscale AI	1	4	3	2	10	0
Shukla, Priyank	Synopsys, Inc.	Synopsys, Inc.	1	4	3	1	9	0
Sikkink, Mark	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	4	4	2	11	0
Simms, William	NVIDIA Corporation	NVIDIA Corporation	1	4	3	2	10	0
sisk, jason	University of New Hampshire InterOperability Laboratory (UNH-IOL)	University of New Hampshire InterOperability Laboratory (UNH-IOL)	1	4	3	1	9	0
Slavick, Jeff	Broadcom Inc	Broadcom Inc	1	4	4	2	11	0
Sommers, Scott	Molex LLC	Molex Incorporated	1	4	4	2	11	0
Son, Yung Sung	Optomind Inc	Optomind Inc	1	5	4	0	10	0
Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDRIES	1	4	3	2	10	0
Srivastava, Atul	NEL-America	NTT Electronics	1	5	3	0	9	0
St-Denis, Bernie	NXP Semiconductors	NXP Semiconductors	0	1	0	0	1	0
Stencel, Leonard		TDK Corporation of America	1	4	4	1	10	0

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Strohmeier, Heiko	Robert Bosch GmbH	Robert Bosch GmbH	1	4	4	2	11	0
Sun, jingcong	Motorcomm Electronic Technology Co	Motorcomm Electronic Technology Co	1	0	0	0	1	0
Sun, Wensheng	Credo Semiconductor	Credo Semiconductor	1	5	3	2	11	0
Sun, Yi	Lightera	Lightera	1	5	4	2	12	0
Swenson, Norman	Norman Swenson Consulting	Norman Swenson Consulting; Point2 Technology Inc.; Nokia	1	4	3	2	10	0
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	1FINITY	1	4	4	2	11	0
TAKEUCHI, JUNICHI	JAE Electronics, Inc	JAE Electronics, Inc.	1	4	4	2	11	0
Tan, Kan	Tektronix, Inc.	Tektronix, Inc.	0	4	3	1	8	0
Tan, Yuxuan	Motorcomm	Motorcomm	1	4	4	0	9	0
Tanc, Ahmet		NXP Semiconductors; NXP Semiconductors	1	4	3	2	10	0
Tanz, Simon		BMW AG; BMW Group	1	4	4	0	9	0
Tartaglia, Antonio	Ericsson AB	Ericsson AB	1	4	4	2	11	0
TAZEBAY, MEHMET	Broadcom Corporation	Broadcom Corporation	1	4	4	2	11	0
Theodoras, James	Scintil Photonics	Scintil Photonics	1	4	3	2	10	0
Thomas, Rajan		Acsia Technologies	1	4	4	0	9	0
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT	1	4	2	2	9	0
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.	1	4	3	2	10	0
Torres, Luisma	Knowledge Development for POF SL	KD	1	3	4	2	10	0
Tracy, Nathan	TE Connectivity	TE Connectivity	1	4	4	2	11	0
Tran, Viet	Keysight Technologies	Keysight Technologies	1	4	4	0	9	0
Tu, Mike	Broadcom Corporation	Broadcom Corporation	1	2	2	1	6	0
Turner, Max	Ethernovia	Ethernovia	1	3	2	2	8	4
Umar, Ashraf		Molex Incorporated	1	1	2	2	6	0
Vakilian, Kambiz	Broadcom Corporation	Broadcom Corporation	1	4	4	2	11	0
Val, Inaki	MaxLinear, Inc.	MaxLinear, Inc.	0	1	0	0	1	0
van Dyck, Peter	Infineon Technologies	Infineon Technologies	1	4	4	2	11	0

Maximum of 4 reciprocal credits are allowed

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Total	Reciprocal Credits
Vanderlaan, Paul	Panduit Corp.	Panduit Corp.	1	4	4	2	11	0
Veloso Cauce, Gumersindo	BMW Group	BMW AG; BMW Group	1	4	4	2	11	0
Venkataraman, Srinivas	Broadcom Corporation	Broadcom Corporation	1	4	3	2	10	0
Voss, Robert	Panduit	Panduit Corp.	1	4	2	2	9	0
Wang, Haojie	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)	1	2	2	0	5	0
Wang, Shun-Sheng	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	1	5	2	2	10	0
Wang, Tongtong	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	4	4	0	9	0
Wang, Xiaofeng	Qualcomm Incorporated	Qualcomm Incorporated	1	4	3	2	10	0
WANG, Xuebo	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	4	4	2	11	0
Wang, Yutao		Rockwell Automation	1	5	2	2	10	0
Watanabe, Yojiro	Mitsubishi Electric US, Inc.	Mitsubishi Electric US, Inc.	0	3	0	1	4	0
Weaver, James	Arista Networks	Arista Networks	1	4	4	2	11	0
Wei, Terry		Analog Devices Inc.	1	4	4	2	11	0
Welch, Brian	Cisco Systems, Inc.	Luxtera	0	4	4	2	10	0
Wienckowski, Natalie	IVN Solutions LLC	IVN Solutions LLC; Ethernovia, Bosch	1	5	4	2	12	0
Wig, Timothy	Samtec, Inc.	Samtec, Inc.	1	4	4	2	11	0
Wingrove, Michael	Ciena Corporation	Ciena Corporation	1	3	3	2	9	0
Withey, James	Fluke Corporation	Fluke Corporation	1	4	3	2	10	0
Wu, Dance	Infineon Technologies	Infineon Technologies	1	2	4	2	9	0
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	5	4	2	12	0
XU, LI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	4	4	1	10	0
xu, wenxiong	HG Genuine	HGGenuine	1	3	3	2	9	0
Xu, Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	4	4	1	10	0
Yamazaki, Kinya	APRESIA Systems	APRESIA Systems	1	5	3	1	10	0
YANG, Yumeng	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	5	4	1	11	0
Yin, Shuang		Google	0	4	4	2	10	0

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Zerna, Conrad	NXP Semiconductors	NXP Semiconductors	1	4	2	2	9	0
ZHANG, KAN		China Mobile (Chengdu) Information and Telecommunication	1	0	0	0	1	0
Zhang, Tingting	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	5	3	2	11	0
Zhang, Wei		Broadcom Corporation	1	5	3	2	11	0
ZHU, YUE		Huawei Technologies Co., Ltd	1	5	4	2	12	0
Zhuang, Shu		Anritsu Company	1	4	4	0	9	0
Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	5	4	2	12	0
Zimmerman, George	CME Consulting, Inc.	CME Consulting; Analog Devices; Cisco; Eliyan; Infineon; OnSemi; Sony	1	5	3	2	11	0
Zivny, Pavel	Lumilens	Lumilens	0	0	3	2	5	0
Zou, Congshi	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	4	4	2	11	0